

Features:

- ◇ P-LCC-4 package.
- \diamond White package.
- ♦ Optical indicator.
- \diamond Colorless clear window.
- $\diamond~$ Ideal for backlight and light pipe application.
- \diamond Inter reflector.
- \diamond Wide viewing angle.
- $\diamond~$ Suitable for vapor-phase reflow, Infrared reflow and wave solder processes.
- ♦ Computable with automatic placement equipment.
- \diamond Available on tape and reel (8mm Tape).
- \diamond The product itself will remain within RoHS compliant Version.

Descriptions:

This series is available in soft orange, green, blue and yellow. Due to the package design, the LED has wide viewing angle and optimized light coupling by inter reflector. This feature makes the SMT TOP LED ideal for light pipe application. The low current requirement makes this device ideal for portable equipment or any other application

Applications:

- ♦ Automotive: Backlight in dashboards and switches.
- $\diamond~$ Telecommunication: Indicator and backlight in telephone and fax
- $\diamond~$ Indicator and backlight for audio and video equipment.
- $\diamond~$ Indicator and backlight in office and family equipment.
- $\diamond~$ Flat backlight for LCD's, switches and symbols.
- \diamond Light pipe application.
- ♦ General use.



Package Dimension: 3.2(.126)± 0.2 ф2.4(.094) 3 22 \sim - 3 GREEN 4 + • 4 2.2 ± 0.2 8± 0.2 2 • - 2 RED 1 Cathode 3.5(.138)±0.2 Polarity Mark 0.8(.031) 0.15(.006) **Recommended Soldering Pad Dimensions** $0.8(.031) \pm 0.3$ 0.9 0.8 0.8 0.6 2 0.9 1 1.2 1.65 1.65 3 4 Unit: mm 1.5 Tolerance: ± 0.10 mm

Part No.	Chip Material	Lens Color	Source Color
	AlGaInP	Water Clear	Hyper Red
R352819-FLWC-V150-UG100	AlGaInP	Water Clear	Super Yellow Green

Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerance is \pm 0.10mm (.004") unless otherwise specified.
- 3. Specifications are subject to change without notice.





Absolute Maximum Ratings at $Ta=25^{\circ}C$

Parameters	Symbol	Emitting Color	Max.	Unit	
		Hyper Red	60	mW	
Power Dissipation	PD	Super Yellow Green	60		
Peak Forward Current		Hyper Red	100	mA	
(1/10 Duty Cycle, 0.1ms Pulse Width)	IFP	Super Yellow Green	100		
		Hyper Red	25		
Continuous Forward Current	IF	Super Yellow Green	25	mA	
Reverse Voltage	VR		5	V	
Flectrostatic Discharge (UDM)		Hyper Red	2000	V	
Electrostatic Discharge (HBM)	ESD	Super Yellow Green	2000	V	
Operating Temperature Range	Topr	-40℃ to +80℃			
Storage Temperature Range	Tstg	-40℃ to +85℃			
Soldering Temperature	Tsld	260°C for 5 Seconds			





Parameters	Symbol	Emitting Color	Min.	Тур.	Max.	Unit	Test Condition
	IV	Hyper Red	100	150			IF=20mA (Note 1)
Luminous Intensity		Super Yellow Green	30	100		mcd	
	20 _{1/2}	Hyper Red		120		Deg	IF=20mA (Note 2)
Viewing Angle		Super Yellow Green		120			
	λр	Hyper Red		632		nm	IF=20mA
Peak Emission Wavelength		Super Yellow Green		575			
Dominant Wavelength	λd	Hyper Red		624		nm	IF=20mA (Note 3)
		Super Yellow Green		573			
	Δλ	Hyper Red		20			IF=20mA
Spectral Line Half-Width		Super Yellow Green		20		nm	
	VF	Hyper Red	1.60	2.00	2.40		IF=20mA
Forward Voltage		Super Yellow Green	1.60	2.00	2.40	V	
	IR	Hyper Red			10	μA	V _R =5V
Reverse Current		Super Yellow Green			10		

Notes:

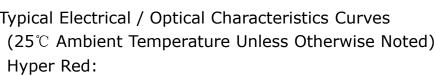
1. Luminous Intensity Measurement allowance is \pm 10%.

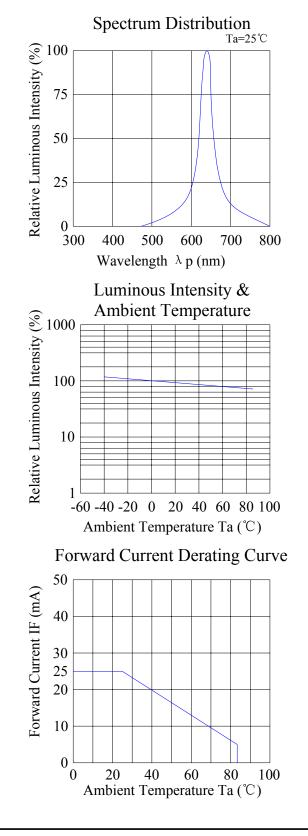
2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.

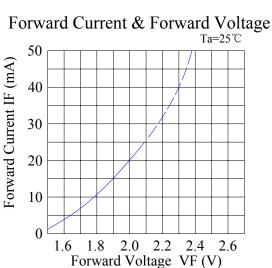
3. The dominant wavelength (λ d) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.



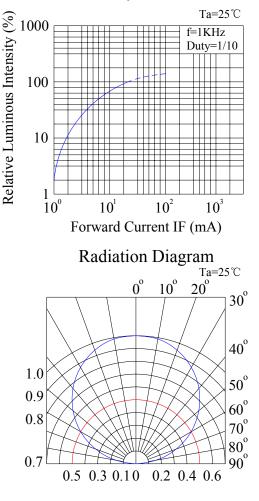








Luminous Intensity & Forward Current



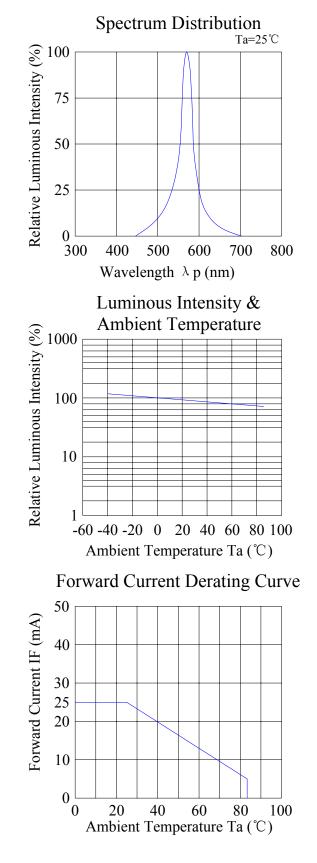


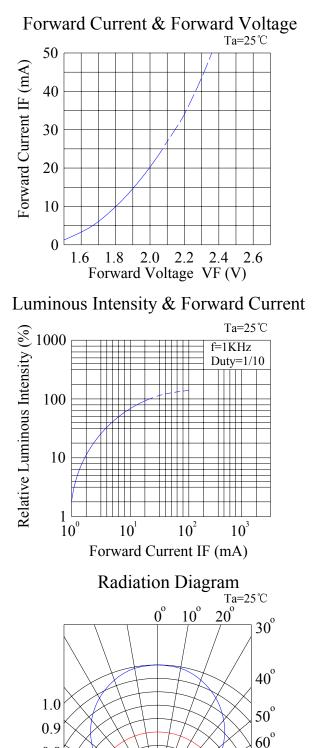
 70°

80° 90°

0.2 0.4 0.6

Super Yellow Green:





0.8

0.7

0.5 0.3 0.10





Reliability Test Items And Conditions:

The reliability of products shall be satisfied with items listed below:

Confidence level: 90%.

LTPD: 10%.

1) Test Items and Results:

No.	Test Item	Test Hours/Cycles	Test Conditions	Sample Size	Ac/Re
1	Resistance to Soldering Heat	6 Min	Tsld=260±5℃, Min. 5sec	25pcs	0/1
2	Thermal Shock	300 Cycles	H: +100℃ 5min ∫ 10 sec L: -10℃ 5min	25pcs	0/1
3	Temperature Cycle	300 Cycles	H: +100℃ 15min ∫ 5min L: -40℃ 15min	25pcs	0/1
4	High Temperature Storage	1000Hrs.	Temp: 100 ℃	25pcs	0/1
5	DC Operating Life	1000Hrs.	IF=20mA	25pcs	0/1
6	Low Temperature Storage	1000Hrs.	Temp: -40 ℃	25pcs	0/1
7	High Temperature/ High Humidity	1000Hrs.	85℃/85%RH	25pcs	0/1

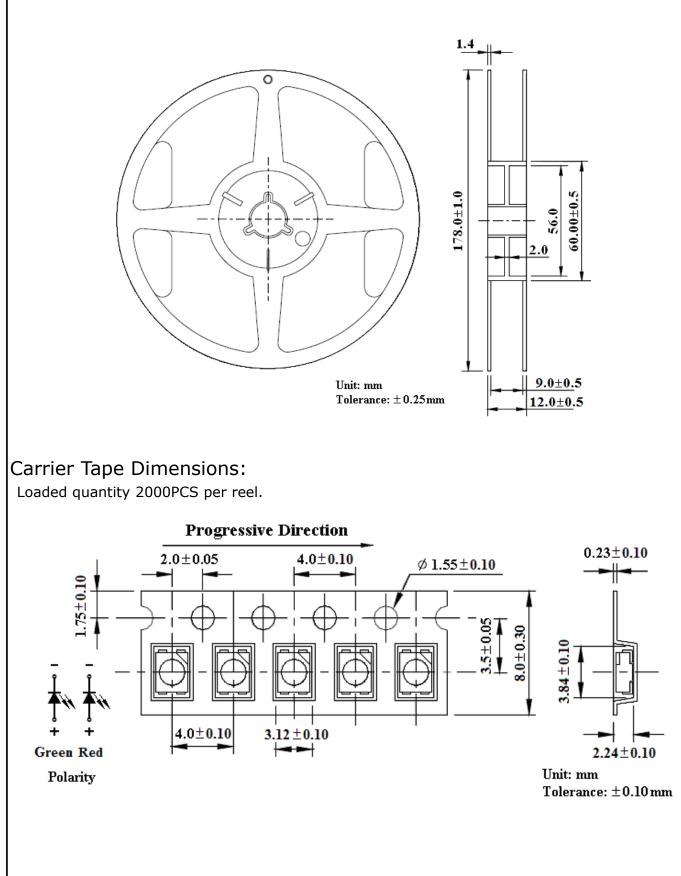
2) Criteria for Judging the Damage:

Itom	Symbol	Test Conditions	Criteria for Judgment		
Item	Symbol		Min	Max	
Forward Voltage	VF	IF=20mA		F.V.*)×1.1	
Reverse Current	IR	VR=5V		F.V.*)×2.0	
Luminous Intensity	IV	IF=20mA	F.V.*)×0.7		

*) F.V.: First Value.



Reel Dimensions:





Please read the following notes before using the product:

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package, the LEDs should be kept at $30\,^\circ\!\!\mathrm{C}$ or less and 80%RH or less.

2.3 The LEDs should be used within a year.

2.4 After opening the package, the LEDs should be kept at $30\,^\circ\!\!\mathrm{C}$ or less and 60%RH or less.

2.5 The LEDs should be used within 168 hours (7 days) after opening the package.

2.6 If the moisture adsorbent material has fabled away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment: $60\pm5^{\circ}$ for 24 hours.

3. Soldering Condition

When soldering, for Lamp without stopper type and must be leave a minimum of 3mm clearance from the base of the lens to the soldering point.

To avoided the Epoxy climb up on lead frame and was impact to non-soldering problem, dipping the lens into the solder must be avoided.

Do not apply any external stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering conditions:

Soldering Iron		Wave Soldering		
Temperature Soldering Time	300℃ Max. 3 sec. Max. (one time only)	Pre-heat Pre-heat Time Solder Wave Soldering Time	100℃ Max. 60 sec. Max. 260℃ Max. 5 sec. Max.	

Note: Excessive soldering temperature and / or time might result in deformation of the LED lens or catastrophic failure of the LED.

4. Soldering Iron

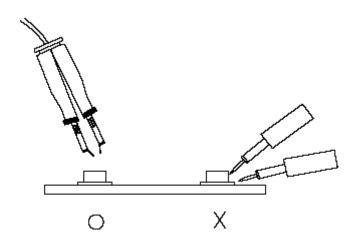
Each terminal is to go to the tip of soldering iron temperature less than 260° for 5 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.







6. Caution in ESD

Static Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.